## 20151013000 Information Only Attachments

## **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	<b>CUSTOMER PART NUMBER</b>
LM22677QTJE-5.0/NOPB	null
LM22677QTJE-ADJ/NOPB	null
LM22677TJ-ADJ/NOPB	null
LM22677TJE-5.0/NOPB	null
LM22677TJE-ADJ/NOPB	null

Technical details of this Product Change follow on the next page(s).

<b>Notification Number:</b>	20151013000 Notification I				on Dat	te: 10/23/2015	
Title: Datasheet update for LM22677/LM22677-Q1							
<b>Customer Contact:</b>	N Manager				ot:	Quality Services	
Change Type:						•	
Assembly Site		Design			Wafer	Bump	Site
Assembly Process		Data Sheet					Material
Assembly Materials		Part number	· change		Wafer	Bump	Process
Mechanical Specification Test Site					Wafer		
Packing/Shipping/Labeling		Test Process					laterials
					Wafer	Fab P	rocess
		tification	<u>Details</u>				
<b>Description of Change</b>	:						
Texas Instruments Incor The product datasheet(s LM22677, LM22677-Q1 SNVSS820_SEPTEMBER 2008_REVIS	) is updated as					elow: <b>ia</b> Tex	TAS TRUMENTS
SINVS502U - SEPTEMBER 2000-REVIS	ED AUGUST 2015						www.ti.com
Changes from Revision N (Nov	ember 2014) to Re	vision O					Page
Changes from Revision N (Nov							
	ut						1
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com